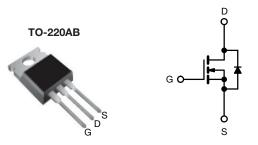
Vishay Siliconix

HALOGEN

FREE

# **E Series Power MOSFET**



N-Channel	

PRODUCT SUMMARY				
V <sub>DS</sub> (V) at T <sub>J</sub> max.	650			
R <sub>DS(on)</sub> max. at 25 °C (Ω)	V <sub>GS</sub> = 10 V	0.158		
Q <sub>g</sub> max. (nC)	95			
Q <sub>gs</sub> (nC)	16			
Q <sub>gd</sub> (nC)	25			
Configuration	Single			

#### **FEATURES**

- Low figure-of-merit (FOM) Ron x Qa
- Low input capacitance (Ciss)
- · Reduced switching and conduction losses
- Ultra low gate charge (Qa)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

#### **APPLICATIONS**

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
  - High-intensity discharge (HID)
  - Fluorescent ballast lighting
- Industrial
  - Welding
  - Induction heating
  - Motor drives
  - Battery chargers
  - Renewable energy
  - Solar (PV inverters)

ORDERING INFORMATION			
Package	TO-220AB		
Lead (Pb)-free and halogen-free	SiHP23N60E-BE3 <sup>a</sup>		
	SiHP23N60E-GE3		

#### Note

a. "-BE3" denotes alternate manufacturing location

ABSOLUTE MAXIMUM RATINGS (To	; – 25 °C, um	iess offici wis	se noteu)			
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-source voltage			$V_{DS}$	600	V	
Gate-source voltage			V <sub>GS</sub>	± 30	V	
Continuous drain current (T <sub>J</sub> = 150 °C)	V <sub>GS</sub> at 10 V	$T_C = 25 ^{\circ}C$ $T_C = 100 ^{\circ}C$	1	23		
	V <sub>GS</sub> at 10 V	T <sub>C</sub> = 100 °C	I <sub>D</sub>	15	Α	
Pulsed drain current <sup>a</sup>	I <sub>DM</sub> 63		63	1		
Linear derating factor				1.8	W/°C	
Single pulse avalanche energy b			E <sub>AS</sub>	353	mJ	
Maximum power dissipation			P <sub>D</sub>	227	W	
Operating junction and storage temperature range		T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C		
Drain-source voltage slope	$T_{J} = 1$	T <sub>J</sub> = 125 °C		37	1//	
Reverse diode dV/dt <sup>d</sup>			dV/dt	34	- V/ns	
Soldering recommendations (peak temperature) c	For 10 s			300	°C	

#### Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature
- b.  $V_{DD}$  = 50 V, starting  $T_J$  = 25 °C, L = 28.2 mH,  $R_q$  = 25  $\Omega$ ,  $I_{AS}$  = 5 A
- c. 1.6 mm from case
- d.  $I_{SD} \le I_D$ ,  $dI/dt = 100 \text{ A/}\mu\text{s}$ , starting  $T_J = 25 \,^{\circ}\text{C}$



# Vishay Siliconix

THERMAL RESISTACNE RATINGS				
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum junction-to-ambient	R <sub>thJA</sub>	-	62	°C/W
Maximum junction-to-case (drain)	R <sub>thJC</sub>	-	0.55	C/VV

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static				•			
Drain-source breakdown voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$		600	-	-	V
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	Reference to 25 °C, I <sub>D</sub> = 1 mA		-	0.72	-	V/°C
Gate-source threshold Voltage (N)	V <sub>GS(th)</sub>	V <sub>DS</sub> =	$V_{DS} = V_{GS}, I_D = 250 \mu\text{A}$		-	4	V
Cata agura laglaga		V <sub>GS</sub> = ± 20 V		-	-	± 100	nA
Gate-source leakage	I <sub>GSS</sub>	\	$V_{GS} = \pm 30 \text{ V}$	-	-	± 1	μΑ
Zoro goto voltago drain ourrent	1	V <sub>DS</sub> =	V <sub>DS</sub> = 600 V, V <sub>GS</sub> = 0 V		-	1	
Zero gate voltage drain current	I <sub>DSS</sub>	$V_{DS} = 480 \text{ V}$	, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 125 °C	-	-	10	μA
Drain-source on-state resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	I <sub>D</sub> = 12 A	-	0.132	0.158	Ω
Forward transconductance	9 <sub>fs</sub>	V <sub>DS</sub> = 30 V, I <sub>D</sub> = 12 A		-	6.4	-	S
Dynamic							
Input capacitance	C <sub>iss</sub>	$V_{GS} = 0 \text{ V},$ $V_{DS} = 100 \text{ V},$ $f = 1 \text{ MHz}$		-	2418	-	pF
Output capacitance	C <sub>oss</sub>			_	119	-	
Reverse transfer capacitance	C <sub>rss</sub>			_	4	-	
Effective output capacitance, energy related <sup>a</sup>	C <sub>o(er)</sub>	V <sub>DS</sub> = 0 V to 480 V, V <sub>GS</sub> = 0 V		-	107	-	
Effective output capacitance, time related <sup>b</sup>	C <sub>o(tr)</sub>			-	320	-	
Total gate charge	Qg			-	63	95	
Gate-source charge	Q <sub>gs</sub>	V <sub>GS</sub> = 10 V		-	16	-	nC
Gate-drain charge	Q <sub>gd</sub>				25	-	
Turn-on delay time	t <sub>d(on)</sub>			-	22	44	
Rise time	t <sub>r</sub>	$V_{DD} = 480 \text{ V}, I_{D} = 12 \text{ A}, V_{GS} = 10 \text{ V}, R_{g} = 9.1 \Omega$		-	38	76	
Turn-off delay time	t <sub>d(off)</sub>			_	66	99	ns
Fall time	t <sub>f</sub>			_	34	68	
Gate input resistance	$R_g$	f = 1 MHz, open drain		-	0.73	-	Ω
Drain-Source Body Diode Characteristic	s						
Continuous source-drain diode current	Is	MOSFET sym showing the	MOSFET symbol showing the		-	23	
Pulsed diode forward current	I <sub>SM</sub>	integral reverse p - n junction diode		-	-	63	- A
Diode forward voltage	V <sub>SD</sub>	T <sub>J</sub> = 25 °C, I <sub>S</sub> = 12 A, V <sub>GS</sub> = 0 V		-	0.9	1.2	V
Reverse recovery time	t <sub>rr</sub>			-	384	768	ns
Reverse recovery charge	Q <sub>rr</sub>	$T_J = 25 ^{\circ}\text{C}, I_F = I_S = 12 \text{A},$ $dI/dt = 100 \text{A/}\mu\text{s}, V_R = 25 \text{V}$		-	6.4	12.8	μC
Reverse recovery current	I <sub>RRM</sub>			_	30	_	Α

### Notes

a.  $C_{oss(er)}$  is a fixed capacitance that gives the same energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$  b.  $C_{oss(tr)}$  is a fixed capacitance that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ 



## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

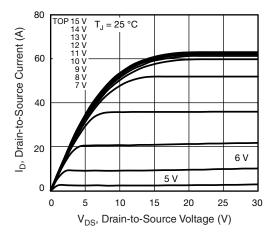


Fig. 1 - Typical Output Characteristics

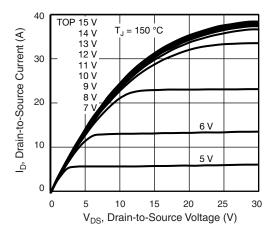


Fig. 2 - Typical Output Characteristics

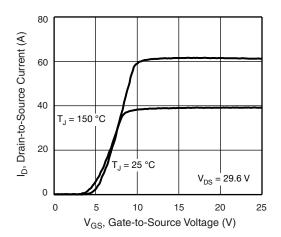


Fig. 3 - Typical Transfer Characteristics

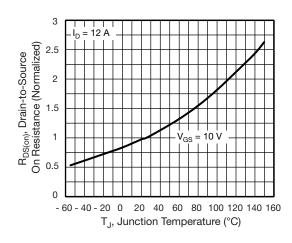


Fig. 4 - Normalized On-Resistance vs. Temperature

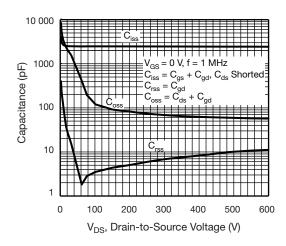


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

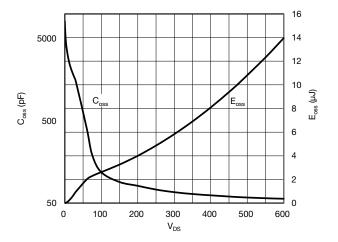


Fig. 6 - Coss and Eoss vs. VDS



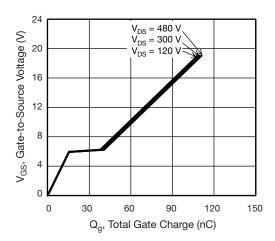


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

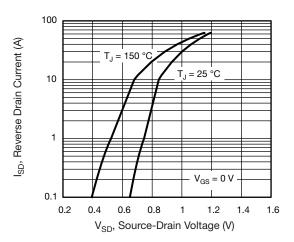


Fig. 8 - Typical Source-Drain Diode Forward Voltage

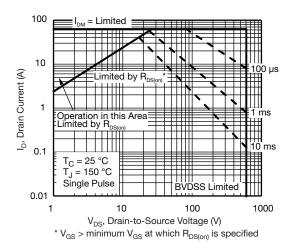


Fig. 9 - Maximum Safe Operating Area

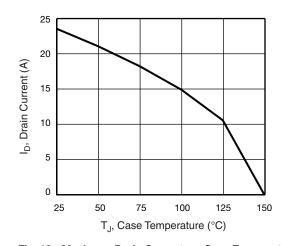


Fig. 10 - Maximum Drain Current vs. Case Temperature

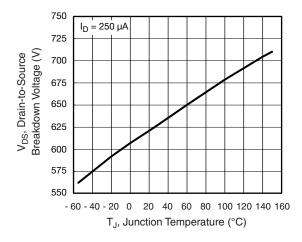


Fig. 11 - Temperature vs. Drain-to-Source Voltage



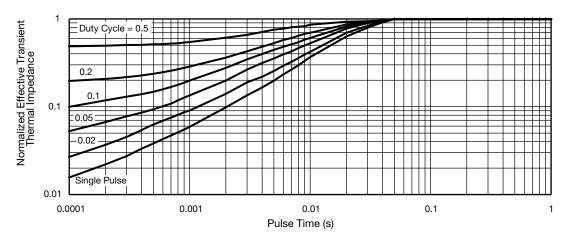


Fig. 12 - Normalized Thermal Transient Impedance, Junction-to-Case

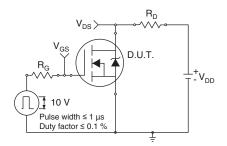


Fig. 13 - Switching Time Test Circuit

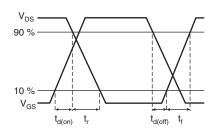


Fig. 14 - Switching Time Waveforms

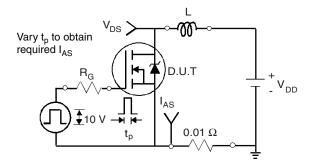


Fig. 15 - Unclamped Inductive Test Circuit

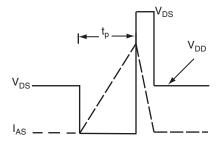


Fig. 16 - Unclamped Inductive Waveforms

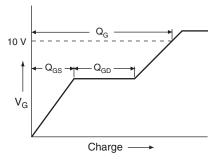


Fig. 17 - Basic Gate Charge Waveform

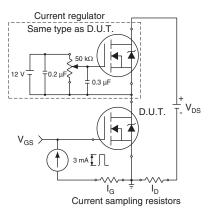
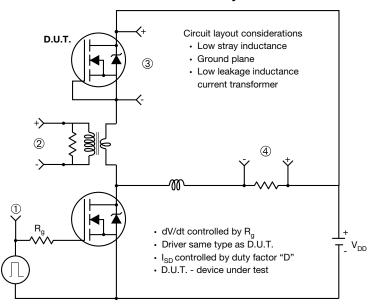


Fig. 18 - Gate Charge Test Circuit



## Peak Diode Recovery dV/dt Test Circuit



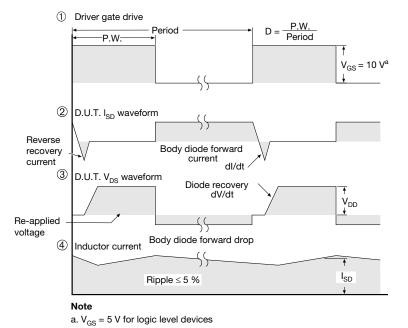


Fig. 19 - For N-Channel

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